



# DB5S406K0R

Silicon epitaxial planar type

For high speed switching circuits  
 DB4J406K in SSMINI5 type package

■ Features

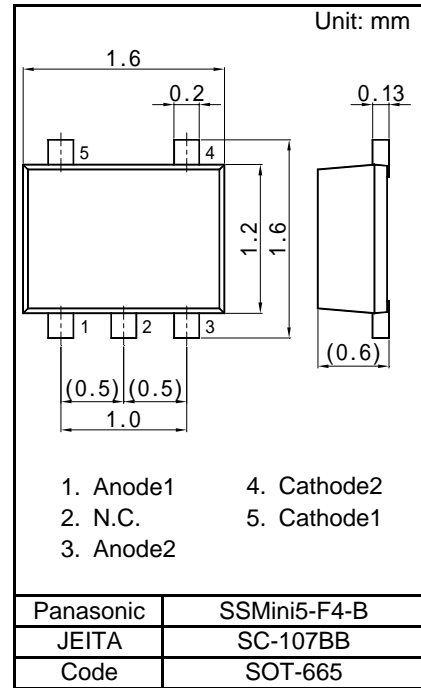
- Small reverse current IR
- Short reverse recovery time trr
- Halogen-free / RoHS compliant  
 (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: 4B

■ Basic Part Number :  
 Dual DB2S406 (Parallel)

■ Packaging

Embossed type (Thermo-compression sealing) : 8 000 pcs / reel (standard)

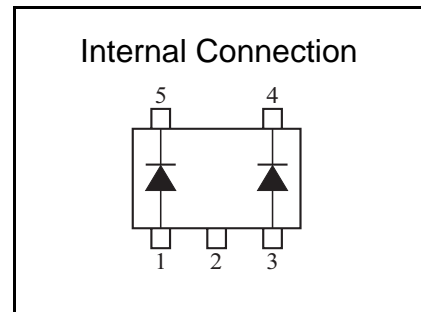


■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Reverse voltage	VR	40	V
Repetitive peak reverse voltage	VRRM	40	V
Forward current (Average)	Single	100	mA
	Double <sup>*1</sup>	75	
Peak forward current	Single	300	mA
	Double <sup>*1</sup>	225	
Non-repetitive peak forward surge current <sup>*2</sup>	Single	1	A
	Double <sup>*1</sup>	0.75	
Junction temperature	Tj	125	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +125	°C

Note: \*1 Value of each diode in double used.

\*2 The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

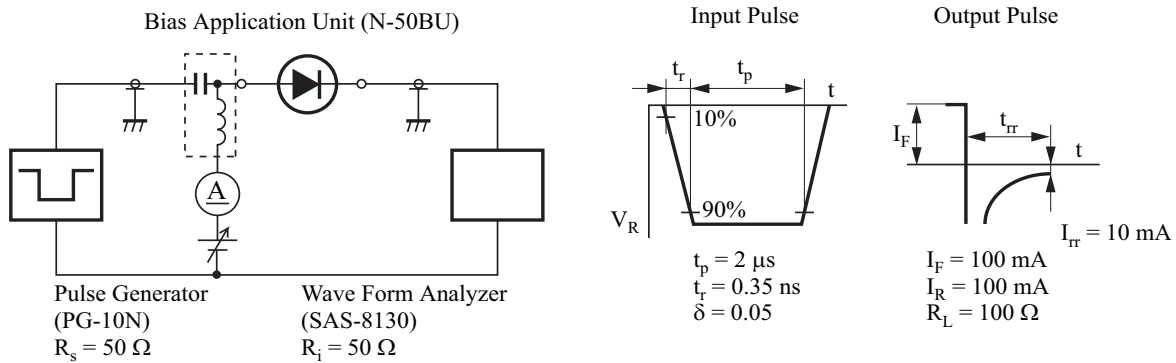




■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	VF1	IF = 1 mA			0.35	V
	VF2	IF = 100 mA			0.60	
Reverse current	IR	VR = 40 V			5	μA
Terminal capacitance	Ct	VR = 10 V, f = 1 MHz		2.2		pF
Reverse recovery time *1	trr	IF = IR = 100 mA, Iirr = 10 mA RL = 100 Ω		0.9		ns

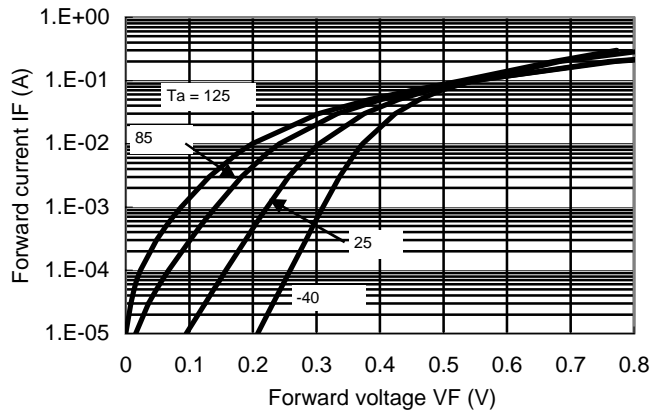
- Note: 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.  
 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.  
 3. Absolute frequency of input and output is 250 MHz.  
 4. \*1 trr test circuit



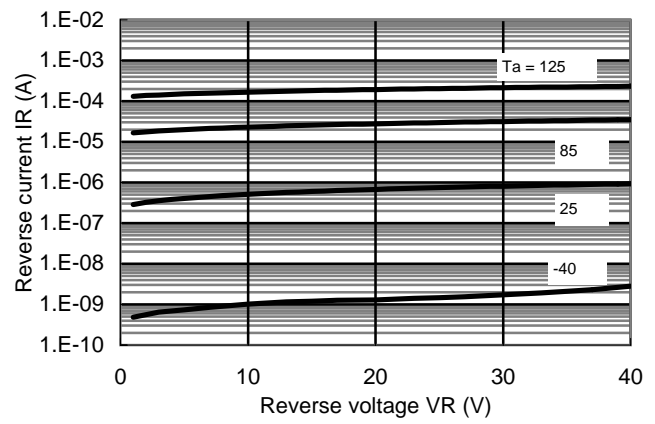


Technical Data ( reference )

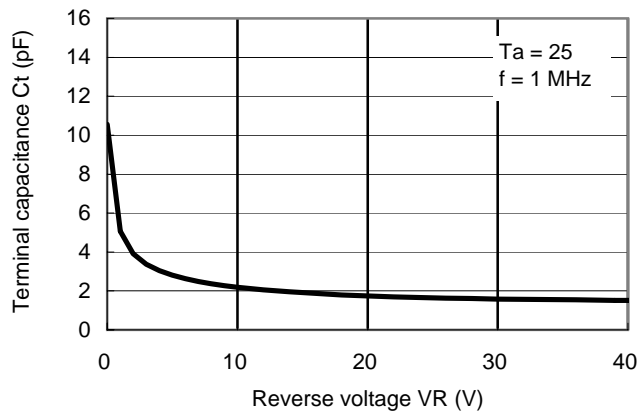
IF - VF



IR - VR



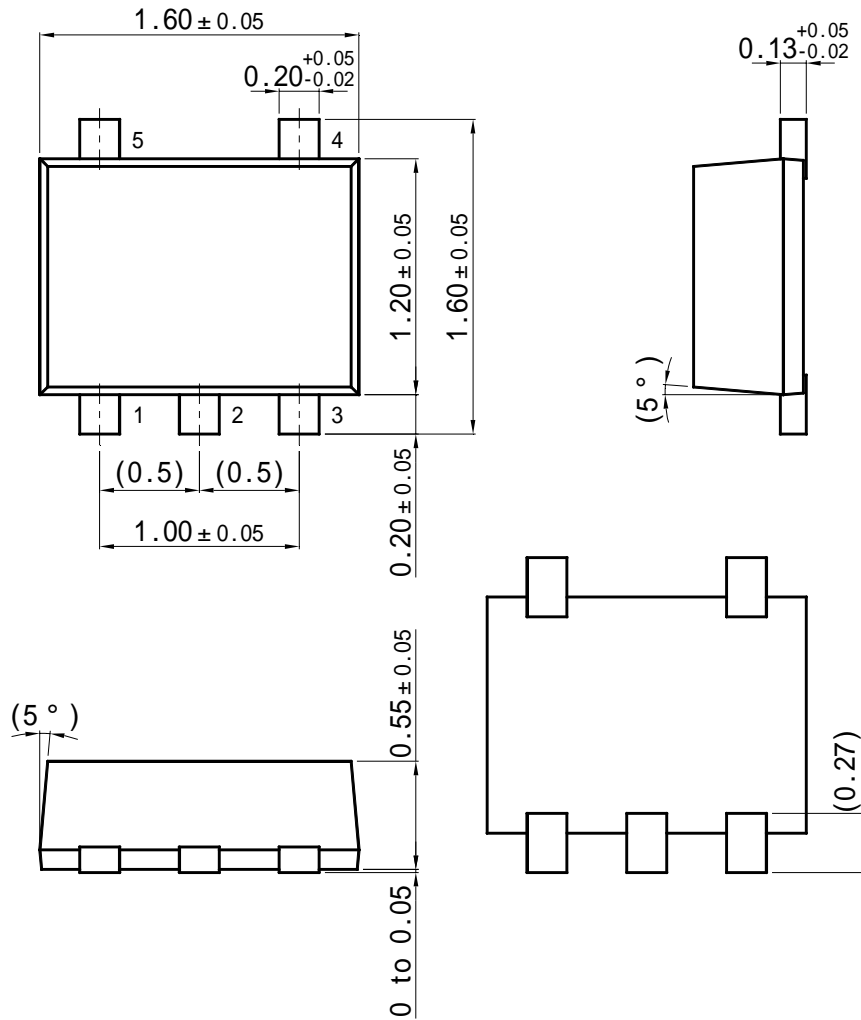
Ct - VR



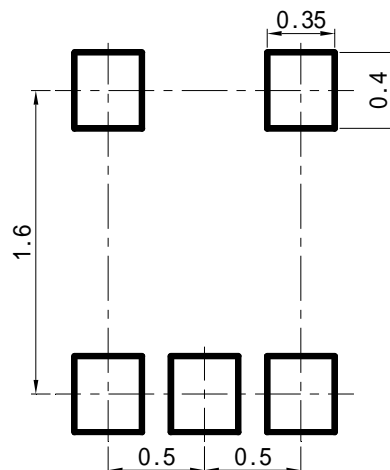
**Panasonic**

SSMini5-F4-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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